

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

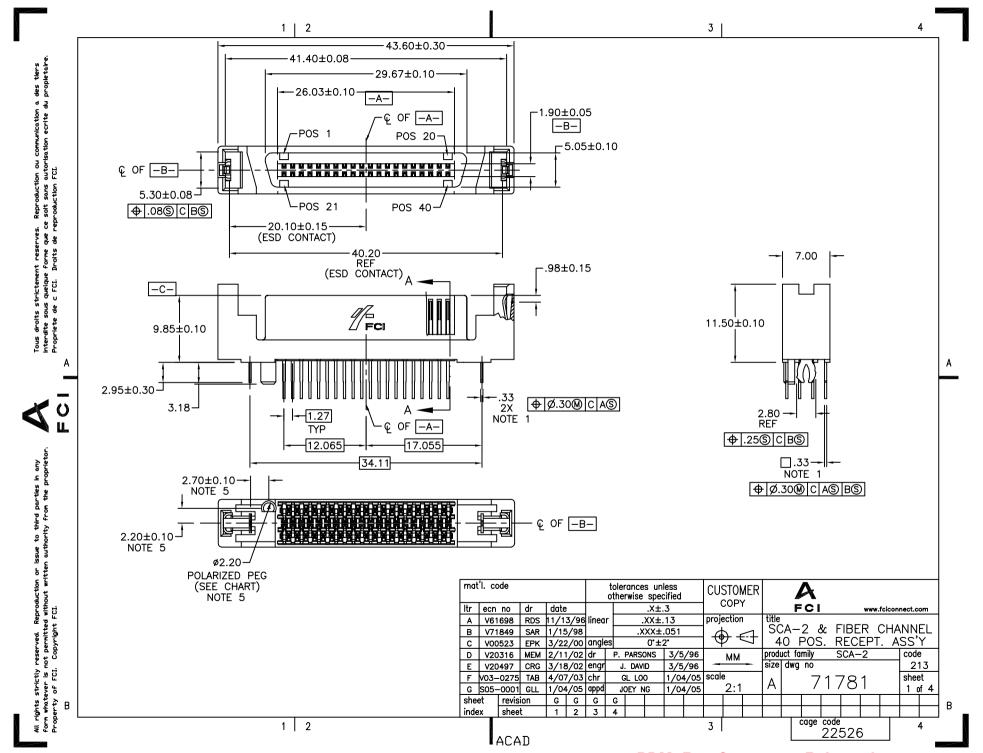
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



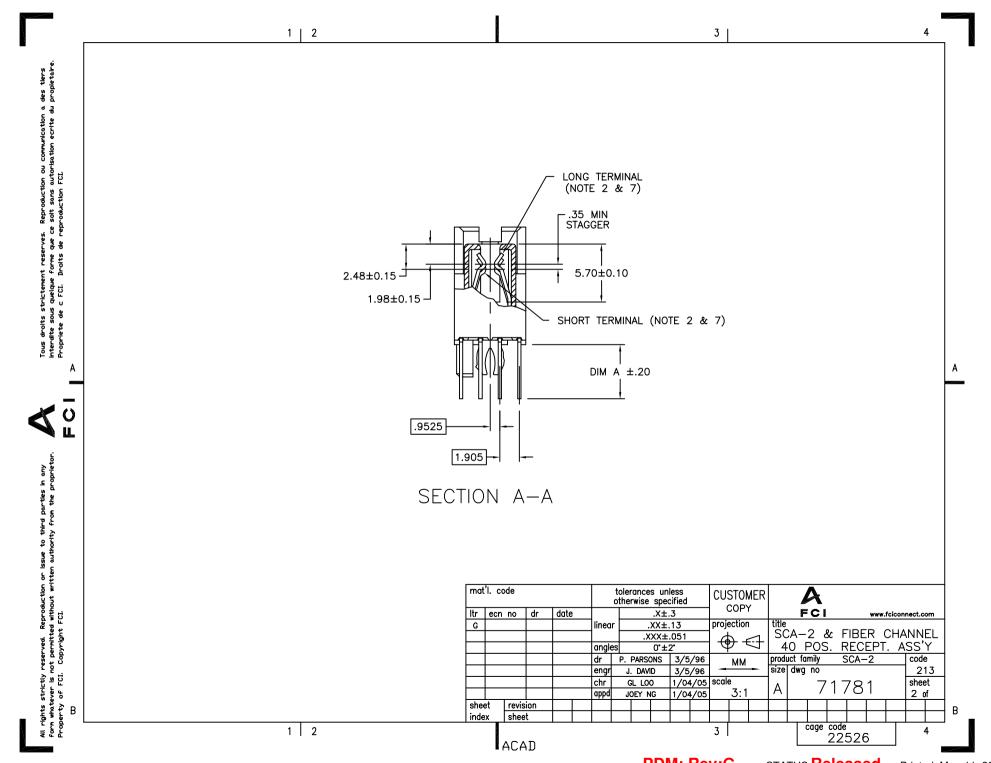






PDM: Rev:G

STATUS: Released



PDM: Rev:G status:Released

NOTES:

				1 -		
PR	ODUCT NO.	"A" DIM	POLARIZATION PEG	RECOMMENDED P.C. BOARD THICKNESS	PLATING	CONTACT POSITIONS
71	781–001	2.79	YES	1.57mm (0.062")		
	-002	2.79	NO	1.5711111 (0.002)		
	-003	3.18	YES	2.76 (0.007")	SEE NOTE 4	SEE NOTE 2
	-004	3.18	NO	2.36mm (0.093")	SEE NOTE 4	SEE NOTE 2
	-005	4.06	YES	3.18mm (0.125")		
	-006	4.06	NO	3.16mm (0.125)		
71	781–007	3.18	YES	2.36mm (0.093")	SEE NOTE 4	SEE NOTE 7
71781-101		2.79	YES	1.57mm (0.062")		
	-102	2.79	NO	1.5711111 (0.002)		
	71781-001 -002 -003 -004 -005 -006 71781-007 71781-101	3.18	YES	2.76~~ (0.007")	SEE NOTE 6	SEE NOTE 2
	-104	3.18	NO	2.36mm (0.093")	SEE NOTE O	JEE NOTE 2
	-105	4.06 YES		3.18mm (0.125")		
71	781–106	4.06	NO	3.16mm (0.125)		

1 | 2

POSN 21-NOTE 5 1.90 TYP. - 2.20±0.10 0000000 NOTE 5 0 0 0 0 0 0 0 0 0 0 0 0.95 0 0 0 0 0 0 0 TYP. 2.60±0.10 DIA. 2.60±0.10 DIA 1) TRUE POSITION NOTES APPLY AT TERMINAL TIP. -Y-CONTACTS IN POSITIONS 1 THRU 20,24,25,27,28, 0.80±0.08 DIA POSN 1 30, 31, 33, AND 34 ARE SHORT TERMINALS. POSN 20 1.27 ф Ø0.05 M Y M CONTACTS IN POSITIONS 21, 22, 23, 26, 29, 32, AND 35 THRU 40 ARE LONG TERMINALS. TYP. 40 PLC 4.99

POSN 40 -

34.11

RECOMMENDED PC BOARD

MOUNTING DIMENSIONS

COMPONENT SIDE

2.70±0.10

RAW MATERIALS: HOUSING: HTN, UL94V-O, COLOR: BLACK CONTACTS: PHOSPHOR-BRONZE

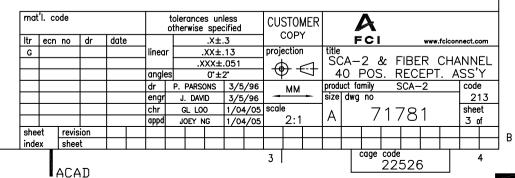
CONTACT PLATING: 30u" (0.76um) MIN. GXT PLATING OVER 50u" (1.27um) NICKLE MIN. UNDERPLATE IN CONTACT AREA. 100u" (2.54um) MIN. TIN-LEAD PLATING OVER 50u" (1.27um) MIN. NICKLE UNDERPLATE IN P.C. BOARD LEG AREA. 50u" (1.27um) MIN. NICKLE UNDERPLATE OVER REMAINING AREA.

DIMENSIONS DO NOT APPLY TO CONNECTOR STYLES WITHOUT POLARIZATION PEG. (SEE CHART)

CONTACT PLATING: 30u" (0.76um) MIN. GOLD PLATING OVER 50u" (1.27um) NICKLE MIN. UNDERPLATE IN CONTACT AREA. 100u" (2.54um) MIN. TIN-LEAD PLATING OVER 50u" (1.27um) MIN. NICKLE UNDERPLATE IN P.C. BOARD LEG AREA. 50u" (1.27um) MIN. NICKLE UNDERPLATE OVER REMAINING AREA.

1 | 2

CONTACTS IN POSITIONS 1 THRU 21, 24, 25, 30-32, 35 & 40 ARE LONG TERMINALS. CONTACTS IN POSITIONS 22, 23, 26, 27, 28, 29, 33, 34, 36-39 ARE SHORT TERMINALS.



3 1

PDM: Rev:G

STATUS: Released

2.60±0.10 DIA

NOTE 5

		'	_		1	
I PRODUCT NO I A DIMI		POLARIZATION PEG	RECOMMENDED P.C. BOARD THICKNESS	PLATING	3	CONTACT POSITIONS
		YES	1.57mm (0.062")			
-002LF	2.79	NO	1.5711111 (0.062)			
-003LF	3.18	YES	2.76 (0.007")	SEE NOTE	a	SEE NOTE 2
-004LF	3.18	NO	2.36mm (0.093")	SEE NOTE	3	SEL NOTE 2
-005LF	4.06	YES	7 18 (0 105")			
-006LF	4.06	NO	3.18mm (0.125")			
71781-007LF	3.18	YES	2.36mm (0.093")	SEE NOTE	9	SEE NOTE 7
71781-101LF	-101LF 2.79 YES	1.57mm (0.062")				
-102LF	2.79	NO	1.5711111 (0.002)			
-103LF	3.18	YES	2.76 (0.007")	SEE NOTE	8	SEE NOTE 2
-104LF	-104LF 3.18		2.36mm (0.093")	SEE NOTE		3LL 1101L Z
-105LF	4.06	YES 7.18 (0.135'				
71781-106LF	4.06	NO	3.18mm (0.125")			
	•				•	

NOTES:

8) CONTACT PLATING: 30u" (0.76um) MIN. GOLD PLATING OVER 50u" (1.27um) NICKLE MIN. UNDERPLATE IN CONTACT AREA. 100u" (2.54um) – 200u" (5.08um) TIN PLATING OVER 50u" (1.27um) – 100u" (2.54um) NICKEL UNDERPLATE IN P.C. BOARD LEG AREA. 50u" (1.27um) NICKEL UNDERPLATE OVER REMAINING AREA.

1 | 2

- © CONTACT PLATING: 30u" (0.76um) MIN. GXT PLATING OVER 50u" (1.27um) NICKLE MIN. UNDERPLATE IN CONTACT AREA. 100u" (2.54um) 200u" (5.08um) TIN PLATING OVER 50u" (1.27um) 100u" (2.54um) NICKLE UNDERPLATE IN P.C. BOARD LEG AREA. 50u" (1.27um) NICKLE UNDERPLATE OVER REMAINING AREA.
- THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.57mm MINIMUM THICK CIRCUIT BOARD.
- (1) THIS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.

mat'l. code						tolerances unless otherwise specified							/ER		A							
ltr	ecn	no	dr	date			.X±.3				COPY		FCI				www.fciconnect.com				om	
G					linea	r 🗌	.XX±.13			proje	ectior	1	title		_							
							.XXX±.051			♦ ←						FIBER CH						
					angle	es	0°±2°				ΨΨ			4	<u>0 l</u>	<u>POS</u>	<u> 6. F</u>	<u>REC</u>	<u>EPT</u>	<u>.</u> А	<u>'SS'</u>	<u>Y</u>
					dr	dr P. PARSONS		3/5/96		ММ		product family				SCA-2			code	e		
					engr	J			3/5/96				size	dwg	lwg no				213		13	
					chr	chr GL LOO appd JOEY NG		1/04/05					ا ۸ ا	7178			72	R 1		sheet		
					appd			1G	1/0	4/05	2:1		Α		/ 1 / 0 1			ı	4 of 4		of 4	
she	et	revis	sion																			
inde	ex sheet																					
404B											3			cage code 22526				4				
	■ 6	4C <i>A</i>	۱U											_					_			

3 I

1 | 2

PDM: Rev:G

STATUS: Released